## (12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

# (19) World Intellectual Property Organization International Bureau





# (43) International Publication Date 23 June 2011 (23.06.2011)

(10) International Publication Number WO 2011/073854 A1

- (51) International Patent Classification: *B29C 45/16* (2006.01) *H05K 5/02* (2006.01)
- (21) International Application Number:

PCT/IB2010/055643

(22) International Filing Date:

7 December 2010 (07.12.2010)

(25) Filing Language:

English

(26) Publication Language:

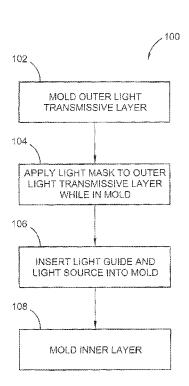
English

- (30) Priority Data:
  200910249094.5 18 December 2009 (18.12.2009) CN
  12/752,263 4 January 2010 (04.01.2010) US
- (71) Applicant (for all designated States except US): SONY ERICSSON MOBILE COMMUNICATIONS AB [SE/SE]; Nya Vattentornet, S-221 88 Lund (SE).

- (72) Inventors: and
- (75) Inventors/Applicants (for US only): WEI, Chenyu [CN/CN]; 210-4-1401 Hui Gu Yang Guang Chaoyang District, Beijing (CN). XING, Jason [CN/CN]; 1-1402 Bokeyaju, Beijing (CN).
- (74) Common Representative: SONY ERICSSON MOBILE COMMUNICATIONS AB; c/o David E. Bennett, Coats & Bennett, PLLC, 1400 Crescent Green, Suite 300, Cary, North Carolina 27518 (US).
- (81) Designated States (unless otherwise indicated, for every kind of national protection available): AE, AG, AL, AM, AO, AT, AU, AZ, BA, BB, BG, BH, BR, BW, BY, BZ, CA, CH, CL, CN, CO, CR, CU, CZ, DE, DK, DM, DO, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, GT, HN, HR, HU, ID, IL, IN, IS, JP, KE, KG, KM, KN, KP, KR, KZ, LA, LC, LK, LR, LS, LT, LU, LY, MA, MD, ME, MG, MK, MN, MW, MX, MY, MZ, NA, NG, NI, NO, NZ, OM, PE, PG, PH, PL, PT, RO, RS, RU, SC, SD,

[Continued on next page]

#### (54) Title: ILLUMINATED MOLDED HOUSING COVER FOR MOBILE COMMUNICATION DEVICE



(57) Abstract: An illuminated housing cover (10) includes a light guide (40) and light source (60) sandwiched between an outer light transmissive layer (20) and an inner layer (30. The light source (60) is disposed at one end of the light guide (40) and arranged so that the emitted light enters one end of the light guide (40). A light mask (50) is disposed between the light guide (40) and the outer light transmissive layer (20) to generate a desired lighting effect or light pattern. The housing cover (10) is manufactured using a two-step molding process.

FIG. 2

- SE, SG, SK, SL, SM, ST, SV, SY, TH, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, ZA, ZM, ZW.
- (84) Designated States (unless otherwise indicated, for every kind of regional protection available): ARIPO (BW, GH, GM, KE, LR, LS, MW, MZ, NA, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European (AL, AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HR, HU, IE, IS, IT, LT, LU, LV, MC, MK, MT, NL, NO, PL, PT, RO, RS, SE, SI, SK, SM, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).

**Declarations under Rule 4.17**:

- as to applicant's entitlement to apply for and be granted a patent (Rule 4.17(ii))
- as to the applicant's entitlement to claim the priority of the earlier application (Rule 4.17(iii))

## Published:

- with international search report (Art. 21(3))
- before the expiration of the time limit for amending the claims and to be republished in the event of receipt of amendments (Rule 48.2(h))

15

20

25

30

35

ILLUMINATED MOLDED HOUSING COVER FOR MOBILE COMMUNICATION DEVICE

#### RELATED APPLICATION

This application claims the benefit under 35 U.S.C. § 119 of Chinese Application Number 200910249094.5, filed in China on December 18, 2009 and U.S. Utility Application 12/752,263 filed April 1, 2010. Both applications are incorporated herein by reference in their entirety.

## BACKGROUND

The present invention relates generally to housings for mobile communication devices and, more particularly, to housings for mobile communication devices having integrated illumination effects. Mobile communication devices, such as mobile telephones, personal digital assistants, and smart phones, have become ubiquitous components of modern life. For many consumers, aesthetics are an important consideration in the selection of a mobile communication device for personal use. Handsome aesthetics not only make the phone attractive to the user, but also provide a means of personal expression to the user. Accordingly, most manufacturers of mobile communication devices continue to search for ways to enhance the aesthetics appeal of their mobile communication devices to consumers. Incorporating illumination or lighting effects into mobile communication devices is one way to enhance the aesthetics of the mobile communication device. Illuminated covers and housings for mobile communication devices are known. More particularly, it is known to place a light source inside the housing for emitting light that passes through a translucent cover to produce a soft glowing effect.

Several problems may be encountered when trying to add illumination or lighting effects to a mobile communication device. First, as the form factor of the mobile communication device decreases, there is less space to accommodate the light source and light guides needed to implement lighting effects. Further, the battery and other components within the mobile communication device cab block light and make it difficult to add illumination effects to some components, such as the battery cover. Accordingly, there continues to be a need for new ways to create lighting effects that can be accommodated in mobile communication devices with small form factors.

## SUMMARY

The present invention relates to a housing cover for a mobile communication device having integrated illumination. The housing cover has a sandwich construction made using a two-shot injection molding process. The housing cover includes a light guide and light source sandwiched between an outer light transmissive layer and an inner layer. The light

10

15

20

25

30

35

source is disposed at one end of the light guide and arranged so that the emitted light enters one end of the light guide. A light mask is disposed between the light guide and the outer light transmissive layer to generate a desired lighting effect or light pattern. Because the light guide and light source are integrally formed with the housing cover during the molding process, it is possible to achieve virtually any lighting effect within a very small form factor. Further, the light will not be obstructed by batteries or other internal components of the mobile communication device.

Exemplary embodiments of the invention comprise a molded housing cover for a mobile communication device. In one embodiment, the molded housing cover comprises an outer light transmissive layer and an inner layer formed into a unitary component by a multishot molding process. A light guide and light source is sandwiched between the outer light transmissive layer and the inner layers during the multi-shot molding process. A light mask between the light transmissive outer layer and the light transmissive outer layer allows light to exit through the cover in a desired pattern.

In some embodiments, the light guide is in surface-to-surface contact with the outer light transmissive layer and the inner layer.

In some embodiments, the outer light transmissive layer comprises a recess for receiving the light source.

In some embodiments, the light source comprises a circuit board insertable into the recess in the outer light transmissive layer and a light source arranged to direct light into one end of the light guide.

In some embodiments, the inner layer comprises an opening exposing contacts on the printed circuit board.

In some embodiments, the light mask comprises a light blocking paint applied in a pattern to one of the outer light transmissive layer and the light guide.

In some embodiments, the light mask comprises a film disposed between the outer light transmissive layer and the light guide.

Other embodiments of the invention comprise methods of manufacturing a light transmissive housing cover for a mobile communication device. One exemplary method comprises molding an outer light transmissive layer of the housing cover during a first molding step; molding an inner layer of the housing cover during a second molding step such that the outer transmissive layer and inner layer form a unitary component; sandwiching a light guide and light source between outer transmissive layer and inner layer during the second molding step; and forming a light mask between the outer light transmissive layer and the light guide.

In some embodiments, sandwiching a light guide and light source between outer transmissive layer and inner layer during the second molding step comprises inserting a light

10

15

20

25

35

guide and light source into the mold adjacent an inside surface of the outer light transmissive layer following the first molding step.

Some embodiments further comprise forming, during the first molding step, a recess in the outer light transmissive layer to receive the light source.

In some embodiments, inserting a light guide and light source into the mold adjacent an inside surface of the outer light transmissive layer comprises inserting the light source into the recess formed in the outer light transmissive layer during the first molding step.

In some embodiments, molding an inner layer of the housing cover comprises molding the inner layer with an opening to expose contacts connected to the light source.

In some embodiments, forming a light mask between the outer light transmissive layer and the light guide comprises applying a light blocking coating to one of the outer light transmissive layer and the light guide.

In some embodiments, forming a light mask between the outer light transmissive layer and the light guide comprises inserting a light blocking film having a pattern of openings between the outer light transmissive layer and the light guide.

## BRIEF DESCRIPTION OF THE DRAWINGS

- Fig. 1 is a schematic section view of an illuminated housing cover according to one embodiment of the invention.
- Fig. 2 illustrates the main process steps in the manufacturing of the illuminated housing cover.
- Fig. 3 illustrates the outer transmissive layer of the housing cover after the first molding step.
- Fig. 4 illustrates the outer transmissive layer of the housing cover after the light mask is applied.
  - Fig. 5 illustrates the insertion of the light guide and light source into the mold adjacent the outer transmissive layer of the housing cover.
    - Fig. 6 illustrates the housing cover after the final molding step.

## 30 DETAILED DESCRIPTION

Referring now to the drawings, Fig. 1 schematically illustrates a housing cover 10 according to one exemplary embodiment of the present invention. The housing cover 10 may comprise, for example, a front cover, back cover, or battery cover of a mobile communication device. As used herein, the term "mobile communication device" refers to any handheld or portable electronic device that is capable of communicating wirelessly with other devices. The term "mobile communication device" includes, without limitation, mobile

10

15

20

25

30

35

telephones, personal digital assistants, smart phones, laptop computers, handheld

computers, and other devices with wireless communication capabilities.

PCT/IB2010/055643

The housing cover 10 is a unitary structure with a sandwich construction made using a two-shot molding process. The main components of the housing cover 10 comprise an outer light transmissive layer 20, an inner layer 30, light guide 40, light mask 50, and light source 60. The outer light transmissive layer 20 is made preferably with a transparent or translucent polycarbonate material, while the inner layer 30 may be made using an opaque polycarbonate or other plastic material. The light guide 40 is made from an optically-transmissive material. The light guide 40 and light source 60 are sandwiched between the outer light transmissive layer 20 and inner layer 30. The light mask 50 is disposed between the light guide 40 and outer light transmissive layer 20 and has a pattern of light transmissive openings that define a lighting pattern. The light source 60 may comprise, for example, a side-fired LED that directs light into one end of the light guide 40. The emitted light is transmitted along the light guide 40. The light is reflected or scattered at desired points to emit the light through the outer transmissive layer 20. Electrical connection with a main circuit board 70 can be made, for example, by a conductive pin 72 that extends from the main circuit board 70 to make contact with light source 60.

Fig. 2 illustrates the main steps in the process 100 for manufacturing the illuminated housing cover 10. In the first step, the outer light transmissive layer 20 is formed by injection molding. As previously noted, the outer light transmissive layer 20 may be made from a transparent polycarbonate material. Fig. 3 illustrates the outer light transmissive layer 20 after the initial molding step. A recess 24 is formed in the inner surface at one end of the outer light transmissive layer 20. As described in greater detail below, the recess 24 receives a printed circuit board (PCB) for the light source 60. A transparent paint 22 is applied to the outer surface of the outer layer 20 during the molding process using well-known coating techniques.

In the second step of the manufacturing process shown in Fig. 2, the light mask 50 is applied to the inner surface of the outer light transmissive layer 20. The light mask 50 may, for example, comprise an opaque paint or other coating that blocks light transmission. Fig. 4 illustrates the outer transmissive layer 20 after the light mask 50 is applied. The light mask 50 includes a pattern of openings or voids 52 where light is allowed to pass through the light mask 50. The openings 52 can be shaped and/or positioned to achieve any desired lighting effect or pattern. While the exemplary embodiment shows the light mask 50 applied to the outer light transmissive layer 20, those skilled in the art will appreciate that the light mask 50 may be applied to the outer light transmissive layer 20 while it remains in the mold.

In the third step of the manufacturing process shown in Fig. 2, the light guide 40 and light source 60 are inserted into the injection mold containing the outer light transmissive

10

15

20

25

30

layer 20. Fig. 5 illustrates the insertion of the light source and light guide into the mold. The light guide 40 comprises a generally planar member made of an optically transmissive material. The light guide 40 includes light reflecting or light scattering features 42 to reflect or scatter light through the openings 52 in the light mask 50. The light source 60 comprises a side-fired light-emitting diode (LED) mounted on a printed circuit board 62. The printed circuit board includes electrical contacts for making electrical connection with the pin 72 on the main circuit board 70. The LED is arranged to emit light into one end of the light guide 40. The light travels along the light guide 40 and is scattered by the light reflecting or scattering features 42 through the openings 52 in the light mask 50.

PCT/IB2010/055643

The fourth step in the manufacturing process shown in Fig. 2 is molding the inner layer 30 of the housing cover 10. The second molding operation encapsulates or sandwiches the light guide 40 and light source 60 between the outer light transmissive layer 20 and inner layer 30. Fig. 6 illustrates the housing cover 10 after the second molding step. The inner layer 30 of the housing cover 10 has an opening 32 at one end to expose the contacts on the printed circuit board 62 of the light source 60. The opening allows electrical connections to be made between the light source 60 and the main circuit board 70 of the mobile communication device. The second molding operation may be performed in the same injection mold used for the initial molding step. The completed housing cover 100 can be removed from the mold when the outer layer 30 cools.

When removed from the mold following the second molding step, the housing cover 10 comprises a unitary component with a sandwich construction. Because the light guide 40 and light source 60 are integrated into the housing cover 10, the housing cover 10 of the present invention solves the problem of integrating illumination into mobile communication devices with small form factors. Using the housing cover 10 of the present invention avoids the need to make space inside the housing to accommodate the light guide 40 and light source 60. Further, the integrated light guide 40 can deliver light to areas of the housing cover 10 that would otherwise be obstructed by the battery or other internal components of the mobile communication device 10.

The present invention may, of course, be carried out in other specific ways than those herein set forth without departing from the scope and essential characteristics of the invention. The present embodiments are, therefore, to be considered in all respects as illustrative and not restrictive, and all changes coming within the meaning and equivalency range of the appended claims are intended to be embraced therein.

## CLAIMS

What is claimed is:

10

15

25

A molded housing cover for a mobile communication device, said housing member
 comprising:

an outer light transmissive layer and an inner layer formed into a unitary component by a multi-shot molding process;

a light guide and light source sandwiched between the outer light transmissive layer and the inner layers during the multi-shot molding process; and a light mask between the light transmissive outer layer and the light guide.

- 2. The molded housing cover of claim 1 wherein the light guide is in surface-to-surface contact with the outer light transmissive layer and the inner layer.
- 3. The molded housing cover of claim 1 wherein the outer light transmissive layer comprises a recess for receiving the light source.
- The molded housing cover of claim 3 wherein the light source comprises a circuit
   board insertable into the recess in the outer light transmissive layer and a light source arranged to direct light into one end of the light guide.
  - The molded housing cover of claim 4 wherein the inner layer comprises an opening exposing contacts on the printed circuit board.
  - 6. The moided housing cover of claim 1 wherein the light mask comprises a light blocking paint applied in a pattern to one of the outer light transmissive layer and the light guide.
- 30 7. The molded housing cover of claim 5 wherein the light mask comprises a film disposed between the outer light transmissive layer and the light guide.
  - 8. A method of manufacturing a light transmissive housing cover for a mobile communication device, the method comprising:

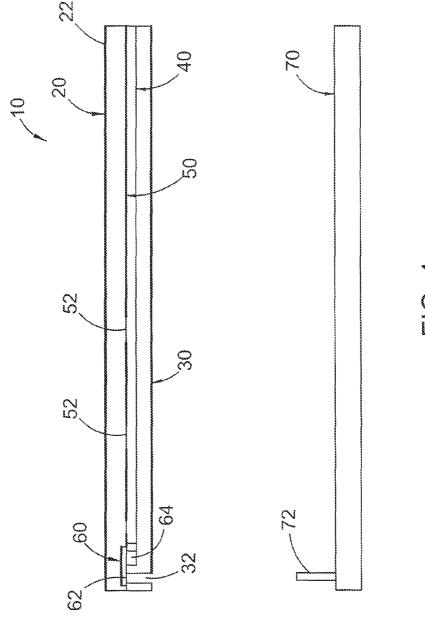
20

25

molding an outer light transmissive layer of the housing cover during a first molding step;

molding an inner layer of the housing cover during a second molding step such that the outer transmissive layer and inner layer form a unitary component; sandwiching a light guide and light source between outer transmissive layer and inner layer during the second molding step; and forming a light mask between the outer light transmissive layer and the light guide.

- 9. The method of claim 8 wherein sandwiching a light guide and light source between outer transmissive layer and inner layer during the second molding step comprises inserting a light guide and light source into the mold adjacent an inside surface of the outer light transmissive layer following the first molding step.
- The method of claim 8 further comprising forming, during the first molding step, a
   recess in the outer light transmissive layer to receive the light source.
  - 11. The method of claim 10 wherein inserting a light guide and light source into the mold adjacent an inside surface of the outer light transmissive layer comprises inserting the light source into the recess formed in the outer light transmissive layer during the first molding step.
  - 12. The method of claim 11 wherein molding an inner layer of the housing cover comprises molding the inner layer with an opening to expose contacts connected to the light source.
  - 13. The method of claim 8 wherein forming a light mask between the outer light transmissive layer and the light guide comprises applying a light blocking coating to one of the outer light transmissive layer and the light guide.
- 30 14. The method of claim 8 wherein forming a light mask between the outer light transmissive layer and the light guide comprises inserting a light blocking film having a pattern of openings between the outer light transmissive layer and the light guide.



Ď

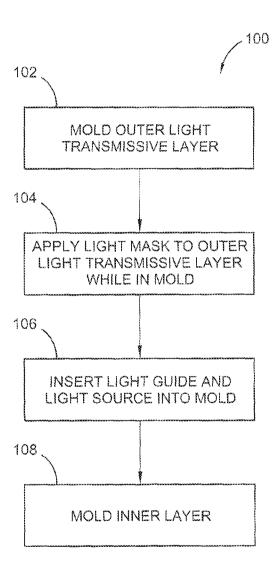
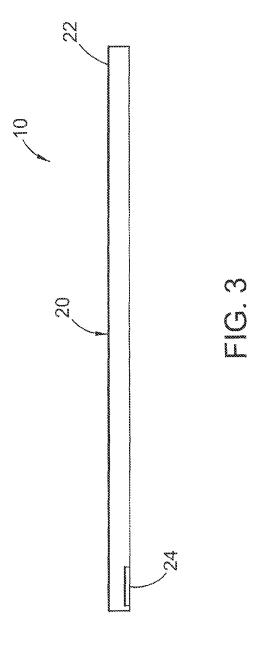
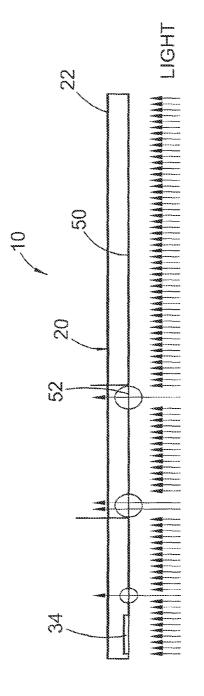
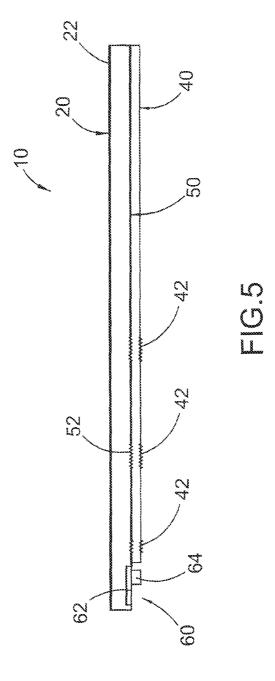
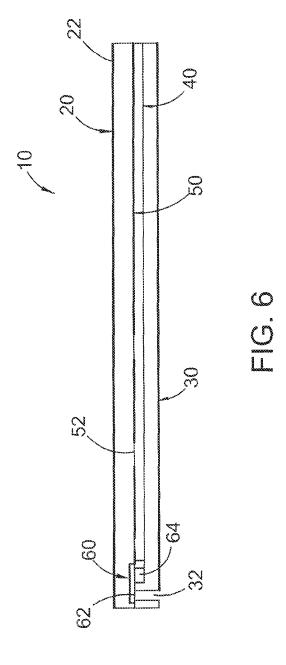


FIG. 2









#### INTERNATIONAL SEARCH REPORT

International application No PCT/IB2010/055643

a. classification of subject matter INV. B29C45/16 H05K H05K5/02 ADD. According to International Patent Classification (IPC) or to both national classification and IPC **B. FIELDS SEARCHED** Minimum documentation searched (classification system followed by classification symbols) B29C H05K H04M Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched Electronic data base consulted during the international search (name of data base and, where practical, search terms used) EPO-Internal, WPI Data C. DOCUMENTS CONSIDERED TO BE RELEVANT Category\* Citation of document, with indication, where appropriate, of the relevant passages Relevant to claim No. γ EP 1 188 534 A2 (NOKIA CORP [FI]) 1 - 1420 March 2002 (2002-03-20) figures 5,6 paragraphs [0021], [0023], [0024] US 5 708 428 A (PHILLIPS JOHN CHARLES γ 1 - 14[US]) 13 January 1998 (1998-01-13) abstract Υ JP 2009 152099 A (SHINETSU POLYMER CO) 1-14 9 July 2009 (2009-07-09) abstract -/--Х Χ Further documents are listed in the continuation of Box C. See patent family annex. Special categories of cited documents: "T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the "A" document defining the general state of the art which is not considered to be of particular relevance invention earlier document but published on or after the international "X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to filing date document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified) involve an inventive step when the document is taken alone "Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such docu-"O" document referring to an oral disclosure, use, exhibition or ments, such combination being obvious to a person skilled in the art. other means document published prior to the international filing date but later than the priority date claimed "&" document member of the same patent family Date of the actual completion of the international search Date of mailing of the international search report 29 April 2011 11/05/2011 Name and mailing address of the ISA/ Authorized officer European Patent Office, P.B. 5818 Patentlaan 2 NL - 2280 HV Rijswijk Tel. (+31-70) 340-2040, Fax: (+31-70) 340-3016 Alink, Maarten

## **INTERNATIONAL SEARCH REPORT**

International application No
PCT/IB2010/055643

C(Continue	tion). DOCUMENTS CONSIDERED TO BE RELEVANT	· · ·
		Delevent to eleien No
Category*	Citation of document, with indication, where appropriate, of the relevant passages  DATABASE WPI	Relevant to claim No.
'	Week 200232 Thomson Scientific, London, GB; AN 2002-274052 XP002634716,	1-14
	& JP 2001 324937 A (HITACHI LTD) 22 November 2001 (2001-11-22) abstract	
Α	US 2009/034273 A1 (CAINE MICHAEL E [US]) 5 February 2009 (2009-02-05) abstract figures 3,4 paragraph [0018]	1
A,P	WO 2010/061840 A1 (NISSHA PRINTING [JP]; NISHIMURA TAKESHI [JP]) 3 June 2010 (2010-06-03) figures 1,2,8 paragraph [0059]	1,8
Т	WO 2011/020946 A2 (PERLOS OYJ [FI]; PELTOLA TERO [FI]; SILVENNOINEN MIKKO [FI]; HIETALA J) 24 February 2011 (2011-02-24) figure 9	
Α	WO 2008/123191 A1 (NISSHA PRINTING [JP]; OKUMURA SHUZO [JP]; OMOTE RYOMEI [JP]; HASHIMOTO) 16 October 2008 (2008-10-16) abstract	1,8
А	US 2008/247538 A1 (WU CHE-TUNG [TW]) 9 October 2008 (2008-10-09) paragraph [0063] figures 2,13,14,15	1,8
Α	JP 9 293972 A (NEC CORP) 11 November 1997 (1997-11-11) abstract	1

## **INTERNATIONAL SEARCH REPORT**

Information on patent family members

International application No
PCT/IB2010/055643

Patent document cited in search report		Publication date	Patent family member(s)			Publication date
EP 1188534	A2	20-03-2002	CN DE DE FI US	1356205 60112522 60112522 20002038 2002048667	D1 T2 A	03-07-2002 15-09-2005 08-06-2006 16-03-2002 25-04-2002
US 5708428	Α	13-01-1998	AU WO	5374698 9826438		03-07-1998 18-06-1998
JP 2009152099	Α	09-07-2009	NONE			
JP 2001324937	Α	22-11-2001	JP	3732070	B2	05-01-2006
US 2009034273	A1	05-02-2009	WO	2009017996	A2	05-02-2009
WO 2010061840	A1	03-06-2010	JP	2010125784	Α	10-06-2010
WO 2011020946	A2	24-02-2011	NONE			
WO 2008123191	A1	16-10-2008	NONE			
US 2008247538	A1	09-10-2008	NONE			
JP 9293972	Α	11-11-1997	NONE			